

08-07-2003



102518365

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Assistant Commissioner for Patents
Washington, District of Columbia, 20231

Recordation Cover Sheet

Dear Sir:

Please record the attached original documents:

8.4.03

1. Name of conveying party (ies):
Eon Silicon Devices, Inc
2. Name and address of receiving party(ies):
Name: **Eon Silicon Solution, Inc**
Address: **6F-2, No. 30, Tai-Yuan Street, Chu-Pei, Hsin-Chu, Taiwan, R.O.C**
3. Nature of conveyance:
Assignment
4. Application number(s) or patent number(s): **09,916,877**

If the application is being filed with together with a new application, the execution date of the application is N/A.

5. Name and address of party to whom correspondence concerning document should be mailed:
Name: **C. P. Chang**
Address: **Pacific Law Group LLP
224 Airport Parkway, Suite 525
San Jose, CA 95110**
6. Total number of applications and patents involved:
One
7. Total fee (37 CFR 3.41)
\$40.00
8. Deposit account number:
N/A
9. Statement and signature:

To the best of my knowledge and belief, the foregoing information is true and correct and any attached copy is a true copy of the original document

K. S. Chiu

Name of Person Signing

Signature

Date

[Handwritten Signature]

7/8 2003

08/06/2003 DBYRNE 00000018 09916877

01 FC:0021 2721-02-10

40.00 DP

OPR/FINANCE
08 AUG -4 AM 10:09

**PATENT
REEL: 014346 FRAME: 0387**

WHEREAS, **Eon Silicon Devices, Inc.**, a corporation duly organized under the laws of California, having a principal place of business 4655 Old Ironsides Drive, Suite 480, Santa Clara, California 95054 hereinafter referred to as "ASSIGNOR", has been the sole legal owner, by way of assignments from its employees-inventors, of the application for United States Letters Patent: An Alternative Related to SAS in Flash EEPROM; Application Serial No 09,916,877, Filing Dated: 07/30/02;

WHEREAS, **Eon Silicon Solution, Inc.**, a Taiwanese corporation located at 6F-2, No. 30, Tai-Yuan Street, Chu-Pei, Hsin-Chu, Taiwan, R.O.C. hereinafter referred to as "ASSIGNEE", is desirous of acquiring the entire right, title and interest in said invention and application and in any Letters Patent which may be granted on the same in accordance with the terms and conditions of a previously executed asset purchase agreement between the parties as of November 27, 2002;

NOW, THEREFORE, TO ALL WHOM IT MAY CONCERN: Be it known that, for One Dollar (\$1.00) and other good and valuable considerations, receipt of which is hereby acknowledged by Assignor, Assignor has sold, assigned and transferred, and by these presents does sell, assign and transfer unto the said Assignee, and Assignee's successors and assigns, all right, title and interest in and to the said invention, said application for United States Letters Patent, and any Letters Patent which may hereafter be granted on the same in the United States and all countries throughout the world including any divisions, renewals, continuations in whole or in part, substitutions, conversions, reissues, prolongations or extensions thereof, said interest to be held and enjoyed by said Assignee as fully and exclusively as it would have been held and enjoyed by said Assignors had this assignment and transfer not been made, to the full end and term of any such Letters Patent.

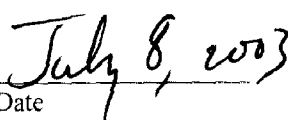
Assignors further agree that he will, without charge to said Assignee, but at Assignee's expense, cooperate with Assignee in the prosecution of said application and/or applications, execute, verify, acknowledge and deliver all such further papers, including applications for Letters Patent and for the reissue thereof, and instruments of assignment and transfer thereof, and will perform such other acts as Assignee lawfully may request, to obtain or maintain Letters Patent for said invention and improvement in any and all countries, and to vest title thereto in said Assignee, or Assignee's successors and assigns.

IN TESTIMONY WHEREOF, Assignors have hereunto signed each of their names to this assignment on the date indicated below.

Eon Silicon Devices, Inc.


By: James Yu

Title: President


Date